

# High Speed Optocoupler, 100 kBd, Low Input Current, Photodiode Darlington Output



## DESIGN SUPPORT TOOLS

[click logo to get started](#)



## DESCRIPTION

High common mode transient immunity and very high current ratio together with 5300  $V_{RMS}$  insulation are achieved by coupling an LED with an integrated high gain photo detector in an eight pin dual-in-line package. Separate pins for the photo diode and output stage enable TTL compatible saturation voltages with high speed operation.

Access to the base terminal allows adjustment to the gain bandwidth.

The 6N139 is suited for low power logic applications involving CMOS and low power TTL applications. A 400 % current transfer ratio with only 0.5 mA of LED current is guaranteed.

**Caution:** Due to the small geometries of this device, it should be handled with Electrostatic Discharge (ESD) precautions. Proper grounding would prevent damage further and/or degradation which may be induced by ESD.

## FEATURES

- High current transfer ratio, 500 %
- Low input current, 1.6 mA
- High common mode rejection, 500 V/ $\mu$ s
- Adjustable bandwidth-access to base
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT

## APPLICATIONS

- Microprocessor system interface
- PLC, ATE input / output isolation
- EIA RS232 line receiver
- TTL, CMOS voltage level translation
- Multiplexed data transmission
- Digital control power supply
- Ground loop and electrical noise elimination

## AGENCY APPROVALS

- [UL 1577](#)
- [cUL](#)
- [DIN EN 60747-5-5 \(VDE 0884-5\), available with option 1](#)

## ORDERING INFORMATION



| AGENCY CERTIFIED/PACKAGE       | CTR (%)                 |
|--------------------------------|-------------------------|
|                                | <b>1.6 mA</b>           |
| <b>UL, cUL</b>                 | <b>&gt; 500</b>         |
| DIP-8                          | 6N139                   |
| SMD-8, option 7                | 6N139-X007, 6N139-X007T |
| SMD-8, option 9                | 6N139-X009, 6N139-X009T |
| <b>UL, cUL, VDE (option 1)</b> | <b>&gt; 500</b>         |
| DIP-8                          | 6N139-X001              |
| SMD-8, option 7                | 6N139-X017T             |
| SMD-8, option 9                | 6N139-X019T             |

### Note

- For additional information on the available options refer to option information



| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |   |               |             |                    |
|--|---|---------------|-------------|--------------------|
| PARAMETER  | TEST CONDITION                            | SYMBOL        | VALUE       | UNIT               |
| <b>INPUT</b>   |   |               |             |                    |
| Reverse voltage  |   | $V_R$         | 5           | V                  |
| Forward current  |   | $I_F$         | 25          | mA                 |
| Average input current  |   | $I_{f(avg)}$  | 20          | mA                 |
| Input power dissipation  |   | $P_{diss}$    | 35          | mW                 |
| <b>OUTPUT</b>  |   |               |             |                    |
| Supply and output voltage  | Pin 8 to 5, pin 6 to 5                    | $V_{CC}, V_O$ | -0.5 to 18  | V                  |
| Emitter base reverse voltage   | Pin 5 to 7                                |               | 0.5         | V                  |
| Peak input current   | 50 % duty cycle - 1 ms pulse width        |               | 40          | mA                 |
| Peak transient input current   | $t_p \leq 1\text{ }\mu\text{s}$ , 300 pps |               | 1           | A                  |
| Output current   | Pin 6                                     | $I_O$         | 60          | mA                 |
| Output power dissipation   |   | $P_{diss}$    | 100         | mW                 |
| <b>COUPLER</b>   |   |               |             |                    |
| Storage temperature  |   | $T_{stg}$     | -55 to +150 | $^{\circ}\text{C}$ |
| Operating temperature  |   | $T_{amb}$     | -55 to +100 | $^{\circ}\text{C}$ |
| Lead soldering temperature   | $t = 10\text{ s}$                         | $T_{sld}$     | 260         | $^{\circ}\text{C}$ |

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability

| <b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |  |           |      |       |      |                        |
|--|--|-----------|------|-------|------|------------------------|
| PARAMETER  | TEST CONDITION   | SYMBOL    | MIN. | TYP.  | MAX. | UNIT                   |
| <b>INPUT</b>   |  |           |      |       |      |                        |
| Input forward voltage  | $I_F = 1.6\text{ mA}$  | $V_F$     | -    | 1.4   | 1.7  | V                      |
| Input reverse breakdown voltage  | $I_R = 10\text{ }\mu\text{A}$  | $B_{VR}$  | 5    | -     | -    | V                      |
| Input capacitance  | $f = 1\text{ MHz}$ , $V_F = 0$   | $C_{IN}$  | -    | 25    | -    | pF                     |
| Temperature coefficient of forward voltage   | $I_F = 1.6\text{ mA}$  |           | -    | -1.8  | -    | mV/ $^{\circ}\text{C}$ |
| <b>OUTPUT</b>  |  |           |      |       |      |                        |
| Logic low, output voltage <sup>(1)</sup>   | $I_F = 1.6\text{ mA}$ , $I_O = 8\text{ mA}$ , $V_{CC} = 4.5\text{ V}$  | $V_{OL}$  | -    | 0.1   | 0.4  | V                      |
|  | $I_F = 5\text{ mA}$ , $I_O = 15\text{ mA}$ , $V_{CC} = 4.5\text{ V}$   | $V_{OL}$  | -    | 0.15  | 0.4  | V                      |
|  | $I_F = 12\text{ mA}$ , $I_O = 24\text{ mA}$ , $V_{CC} = 4.5\text{ V}$  | $V_{OL}$  | -    | 0.25  | 0.4  | V                      |
| Logic high, output current <sup>(1)</sup>  | $I_F = 0\text{ mA}$ , $V_{CC} = 18\text{ V}$   | $I_{OH}$  | -    | 0.05  | 100  | $\mu\text{A}$          |
| Logic low supply current <sup>(1)</sup>  | $I_F = 1.6\text{ mA}$ , $V_O = \text{OPEN}$ , $V_{CC} = 18\text{ V}$   | $I_{CCL}$ | -    | 0.2   | 1.5  | mA                     |
| Logic high supply current <sup>(1)</sup>   | $I_F = 0\text{ mA}$ , $V_O = \text{OPEN}$ , $V_{CC} = 18\text{ V}$   | $I_{CCH}$ | -    | 0.001 | 10   | $\mu\text{A}$          |
| <b>COUPLER</b>   |  |           |      |       |      |                        |
| Input output insulation leakage current  | 45 % relative humidity,<br>$T_{amb} = 25\text{ }^{\circ}\text{C}$ , $t = 5\text{ s}$ , $V_{IO} = 3000\text{ V}_{DC}$ |           | -    | -     | 1    | $\mu\text{A}$          |
| Coupling capacitance   | $f = 1\text{ MHz}$   | $C_{IO}$  | -    | 0.6   | -    | pF                     |

**Notes**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements

<sup>(1)</sup> Pin 7 open

| CURRENT TRANSFER RATIO                |   |        |      |      |      |      |
|---------------------------------------|---|--------|------|------|------|------|
| PARAMETER                             | TEST CONDITION  | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Current transfer ratio <sup>(1)</sup> | $I_F = 0.5 \text{ mA}, V_O = 0.4 \text{ V}, V_{CC} = 4.5 \text{ V}$ | CTR    | 400  | 1600 | -    | %    |
|                                       | $I_F = 1.6 \text{ mA}, V_O = 0.4 \text{ V}, V_{CC} = 4.5 \text{ V}$ | CTR    | 500  | 2000 | -    | %    |

**Notes**

<sup>(1)</sup> Pin 7 open

| SAFETY AND INSULATION RATINGS ( $T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified) |  |            |                |                  |
|---|--|------------|----------------|------------------|
| PARAMETER   | TEST CONDITION   | SYMBOL     | VALUE          | UNIT             |
| Climatic classification   | According to IEC 68 part 1                                     |            | 55 / 100 / 21  |                  |
| Comparative tracking index  | Insulation group IIIa  | CTI        | 175            |                  |
| Maximum rated withstanding isolation voltage  | According to UL 1577, $t = 1 \text{ min}$                      | $V_{ISO}$  | 5300           | $V_{RMS}$        |
| Maximum transient isolation voltage   | According to DIN EN 60747-5-5                                  | $V_{IOTM}$ | 8000           | $V_{peak}$       |
| Maximum repetitive peak isolation voltage   | According to DIN EN 60747-5-5                                  | $V_{IORM}$ | 890            | $V_{peak}$       |
| Isolation resistance  | $T_{amb} = 25 \text{ }^\circ\text{C}, V_{IO} = 500 \text{ V}$  | $R_{IO}$   | $\geq 10^{12}$ | $\Omega$         |
|   | $T_{amb} = 100 \text{ }^\circ\text{C}, V_{IO} = 500 \text{ V}$ | $R_{IO}$   | $\geq 10^{11}$ | $\Omega$         |
| Output safety power   |  | $P_{SO}$   | 500            | mW               |
| Input safety current  |  | $I_{SI}$   | 300            | mA               |
| Input safety temperature  |  | $T_S$      | 175            | $^\circ\text{C}$ |
| Creepage distance   | DIP-8  |            | $\geq 7$       | mm               |
| Clearance distance  |  |            | $\geq 7$       | mm               |
| Creepage distance   | SMD-8, option 7,<br>SMD-8, option 9                            |            | $\geq 8$       | mm               |
| Clearance distance  |  |            | $\geq 8$       | mm               |
| Insulation thickness  |  | DTI        | $\geq 0.4$     | mm               |

**Note**

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits

| SWITCHING CHARACTERISTICS                      |   |           |      |      |      |               |
|--|---|-----------|------|------|------|---------------|
| PARAMETER                                      | TEST CONDITION                                    | SYMBOL    | MIN. | TYP. | MAX. | UNIT          |
| Propagation delay time to logic low at output  | $I_F = 0.5 \text{ mA}, R_L = 4.7 \text{ k}\Omega$ | $t_{PHL}$ | -    | 6    | 25   | $\mu\text{s}$ |
|  | $I_F = 12 \text{ mA}, R_L = 270 \Omega$           | $t_{PHL}$ | -    | 0.6  | 1    | $\mu\text{s}$ |
| Propagation delay time to logic high at output | $I_F = 0.5 \text{ mA}, R_L = 4.7 \text{ k}\Omega$ | $t_{PLH}$ | -    | 4    | 60   | $\mu\text{s}$ |
| Propagation delay time to logic high at output | $I_F = 12 \text{ mA}, R_L = 270 \Omega$           | $t_{PLH}$ | -    | 1.5  | 7    | $\mu\text{s}$ |

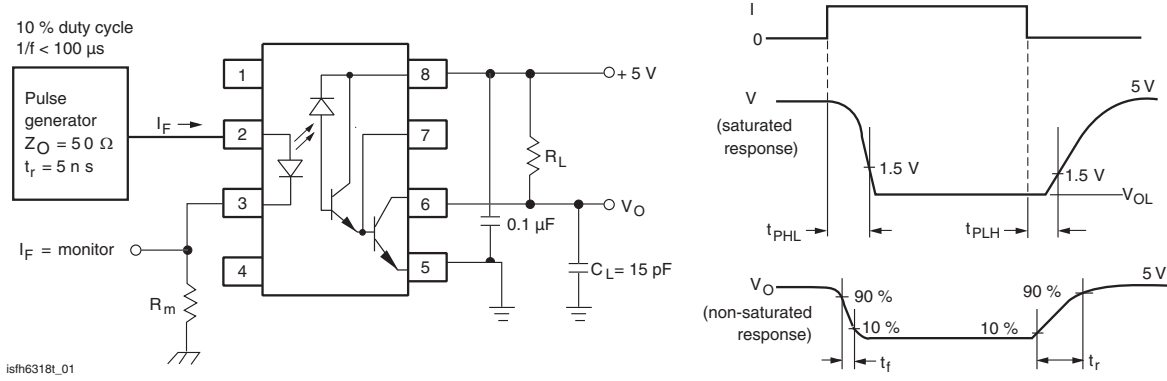


Fig. 1 - Switching Test Circuit

| COMMON MODE TRANSIENT IMMUNITY   |  |          |      |       |      |            |
|--|--|----------|------|-------|------|------------|
| PARAMETER  | TEST CONDITION   | SYMBOL   | MIN. | TYP.  | MAX. | UNIT       |
| Common mode transient immunity, logic high level output <sup>(1)</sup> | $I_F = 0 \text{ mA}$ , $R_L = 2.2 \text{ k}\Omega$ , $R_{CC} = 0$ , $ V_{CM}  = 10 \text{ V}_{P-P}$  | $ CM_H $ | -    | 500   | -    | V/ $\mu$ s |
| Common mode transient immunity, logic low level output <sup>(1)</sup>  | $I_F = 16 \text{ mA}$ , $R_L = 2.2 \text{ k}\Omega$ , $R_{CC} = 0$ , $ V_{CM}  = 10 \text{ V}_{P-P}$ | $ CM_L $ | -    | - 500 | -    | V/ $\mu$ s |

**Note**

<sup>(1)</sup> In applications where  $dV/dt$  may exceed 50 000 V/ $\mu$ s (such as state discharge) a series resistor,  $R_{CC}$  should be included to protect  $I_C$  from destructively high surge currents. The recommend value is  $R_{CC} \equiv [(1 \text{ V})/(0.15 I_F \text{ (mA)})] \text{ k}\Omega$



Fig. 2 - Test Circuit for Transient Immunity and Typical Waveforms

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified)



Fig. 2 - Permissible Forward LED Current vs. Temperature

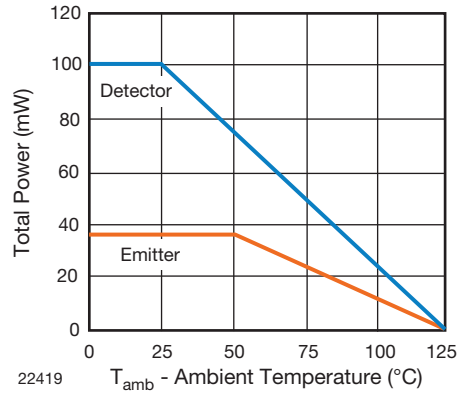


Fig. 3 - Permissible Power Dissipation vs. Temperature



PACKAGE DIMENSIONS (in millimeters)

DIP-8



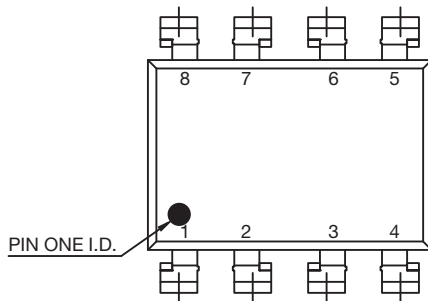
22672

SMD-8, Option 7



22674

SMD-8, Option 9



22675

PACKAGE MARKING



Fig. 3 - Example of 6N139-X017T

Note

- VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking

**PACKING INFORMATION** (in millimeters)

**Tube**

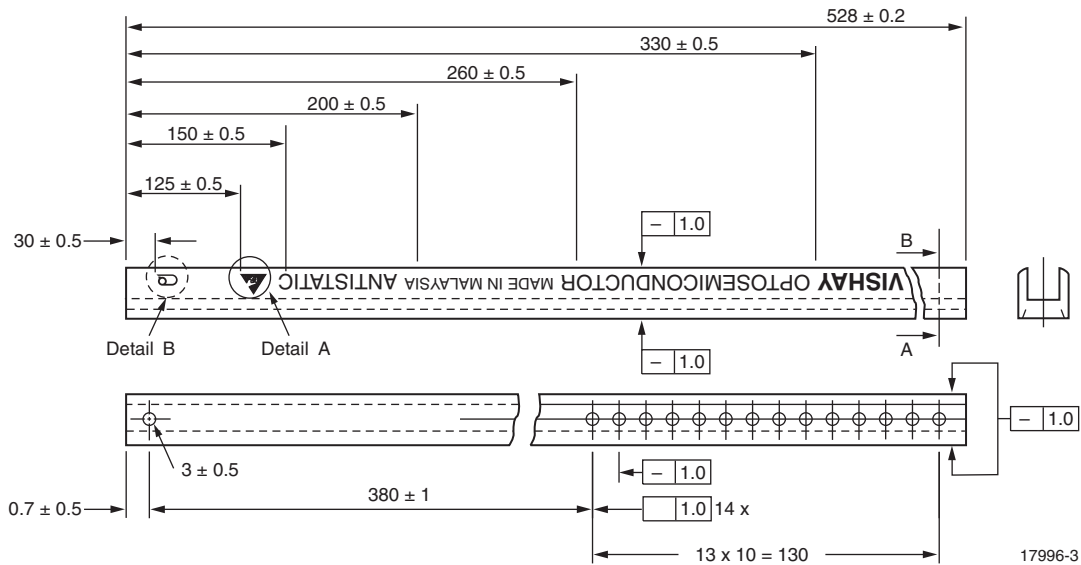


Fig. 4 - Shipping Tube Specifications for DIP-8 Packages

| DEVICES PER TUBS |            |           |           |
|------------------|------------|-----------|-----------|
| TYPE             | UNITS/TUBE | TUBES/BOX | UNITS/BOX |
| DIP-8            | 50         | 40        | 2000      |

**DIP-8**



Fig. 5 - Tube Shipping Medium

Tape and Reel



Fig. 6 - Tape and Reel Shipping Medium

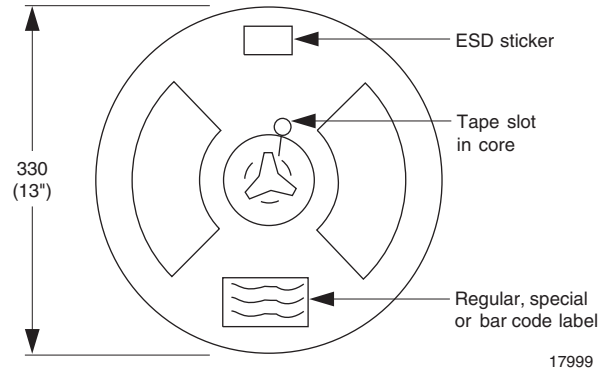


Fig. 7 - Tape and Reel Shipping Medium

SMD-8 (option 7)



Fig. 8 - Tape and Reel Packing (1000 pieces on Reel)

SMD-8 (option 9)

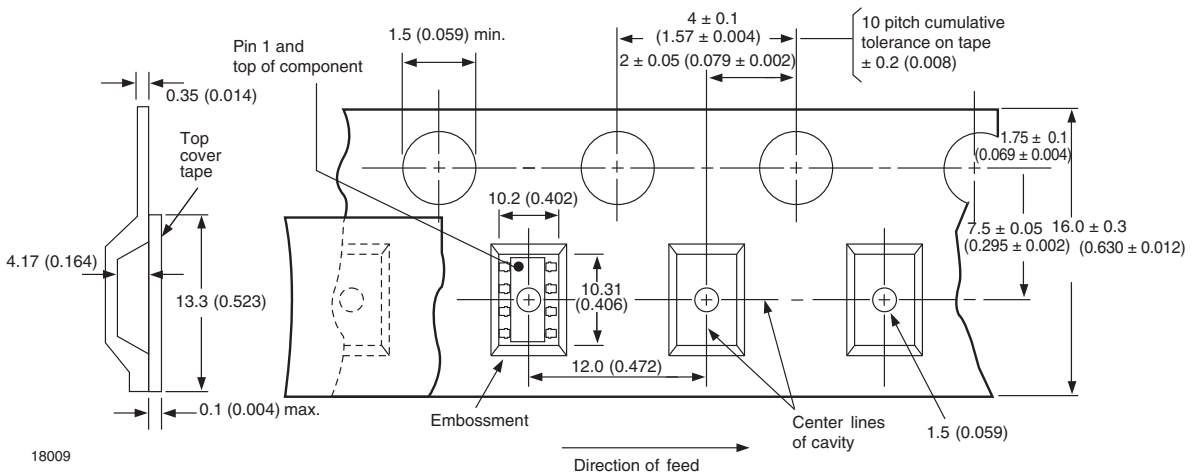


Fig. 9 - Tape and Reel Shipping Medium



**SOLDER PROFILES**



948626

Fig. 10 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP-8 Devices



19841

Fig. 11 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD-8 Devices

**HANDLING AND STORAGE CONDITIONS**

ESD level: HBM class 2

Floor life: unlimited

Conditions:  $T_{amb} < 30\text{ °C}$ , RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.